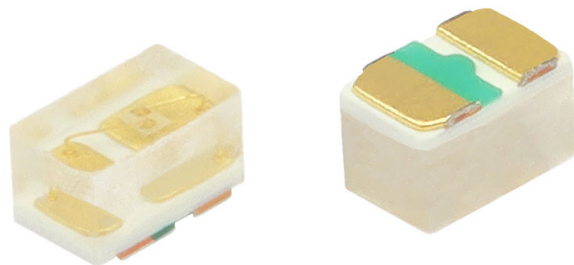


Highbright 0201 ChipLED



DESCRIPTION

The 0201 ChipLED delivers brilliant illumination in one of the smallest surface-mount formats available. Measuring just 0.65 mm x 0.375 mm x 0.35 mm, it is perfectly suited for space-constrained applications in consumer electronics, wearables, industrial systems, and more. This RoHS-compliant component combines ultra compact dimensions, low power consumption, a wide viewing angle, and multiple color options engineered for seamless integration into automated SMT processes. Offering exceptional versatility and performance, the 0201 ChipLED empowers the next generation of compact, high efficiency electronic designs.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD 0201 ChipLED
- Product series: standard
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- Super small ChipLED with high brightness 0.65 x 0.375 x 0.35 (L x W x H in mm)
- High reliability PCB based
- Typical dominant wavelength: 527 nm
- High efficient InGaN technology
- Wide viewing angle: 120°
- Grouping parameter: luminous intensity, dominant wavelength, and forward voltage
- Available in 8 mm tape on 7" diameter reel
- ESD sensitive device, HBM 1000 V
- Compatible to IR reflow soldering
- Preconditioning according to JEDEC® level 3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Backlighting for keypads, logos, and buttons in ultra thin devices
- Instrument illumination
- Indicators and backlight for telecommunication equipment, consumer electronics, and white goods
- Displays for industrial control systems
- Next-generation compact devices and smart accessories
- General use

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I _F (mA)	WAVELENGTH (nm)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMTG1700-GS08	True green	57	-	140	2	520	-	535	2	2.3	-	3.1	2	InGaN / sapphire

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMTG170. (InGaN technology)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V_R	5	V
DC forward current		I_F	25	mA
Surge forward current	1/10 duty cycle, 0.1 ms pulse width	I_{FSM}	50	mA
Power dissipation		P_V	80	mW
Operating temperature range		T_{amb}	-40 to +85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +90	$^{\circ}\text{C}$
ESD withstand voltage	HBM	V_{ESD}	1000	V
Reflow solder conditions	According Vishay specifications	T_{sld}	260	$^{\circ}\text{C}$

Note

- ⁽¹⁾ Reverse voltage is intended for test purposes only; do not operate the device under reverse bias

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMTG170., TRUE GREEN

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 2\text{ mA}$	I_V	57	-	140	mcd
Peak wavelength	$I_F = 2\text{ mA}$	λ_p	-	518	-	nm
Spectral halfwidth	$I_F = 2\text{ mA}$	$\Delta\lambda$	-	35	-	nm
Dominant wavelength	$I_F = 2\text{ mA}$	λ_d	520	-	535	nm
Angle of half intensity	$I_F = 2\text{ mA}$	φ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$	V_F	2.3	-	3.1	V
Reverse current	$V_R = 5\text{ V}$	I_R	-	-	50	μA

LUMINOUS INTENSITY CLASSIFICATION
AT 2 mA

GROUP	LUMINOUS INTENSITY (mcd)	
	MIN.	MAX.
P2	57	72
Q1	72	90
Q2	90	112
R1	112	140

Note

- Tolerance of luminous intensity: $\pm 11\%$

FORWARD VOLTAGE CLASSIFICATION
AT 2 mA

GROUP	FORWARD VOLTAGE (V)	
	MIN.	MAX.
1	2.3	2.7
2	2.7	3.1

Note

- Tolerance of forward voltage: $\pm 0.05\text{ V}$

DOMINANT WAVELENGTH CLASSIFICATION
AT 2 mA

GROUP	DOMINANT WAVELENGTH (nm)	
	MIN.	MAX.
X	520	525
Y	525	530
Z	530	535

Note

- Tolerance of dominant wavelength: $\pm 1\text{ nm}$

Notes

- In order to ensure availability, single groups for luminous intensity, color, and forward voltage will not be orderable
- Only one group for luminous intensity, dominant wavelength, and forward voltage will be shipped in any one reel

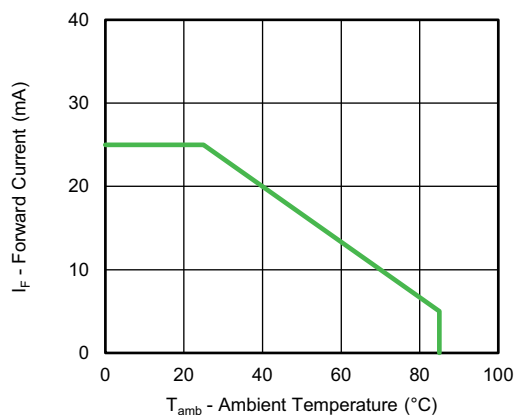
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature

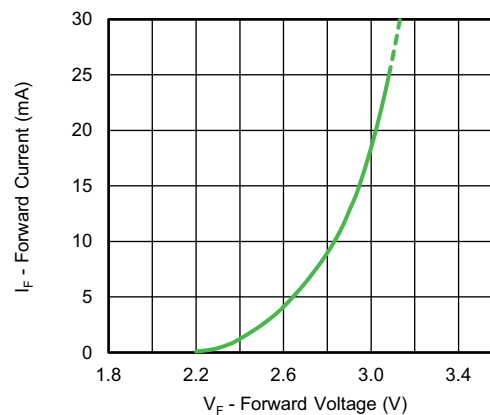


Fig. 4 - Forward Current vs. Forward Voltage

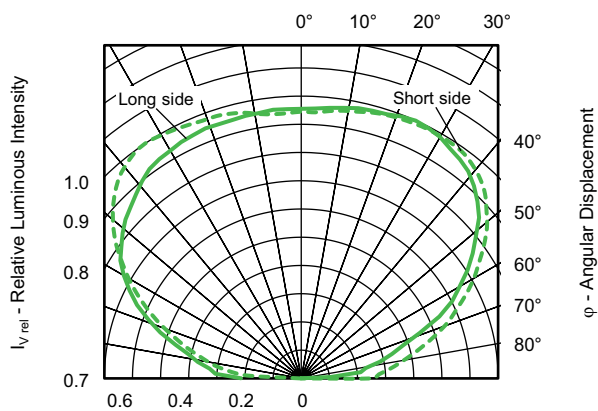


Fig. 2 - Relative Luminous Intensity vs. Angular Displacement

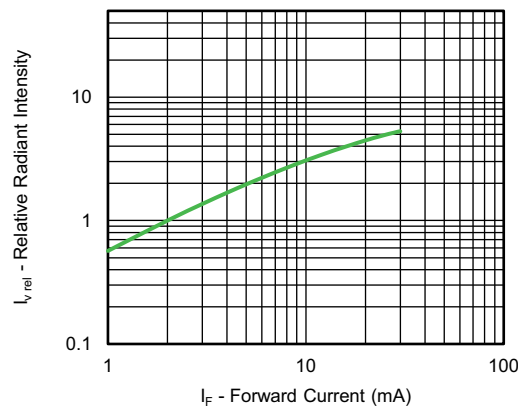


Fig. 5 - Relative Luminous Intensity vs. Forward Current

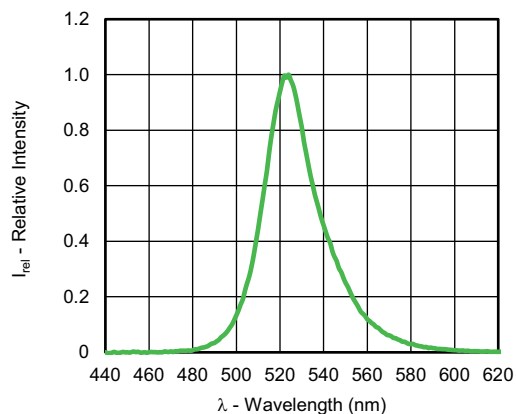


Fig. 3 - Relative Intensity vs. Wavelength

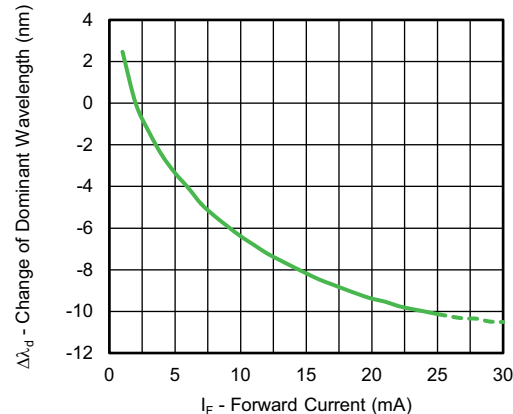


Fig. 6 - Change of Dominant Wavelength vs. Forward Current

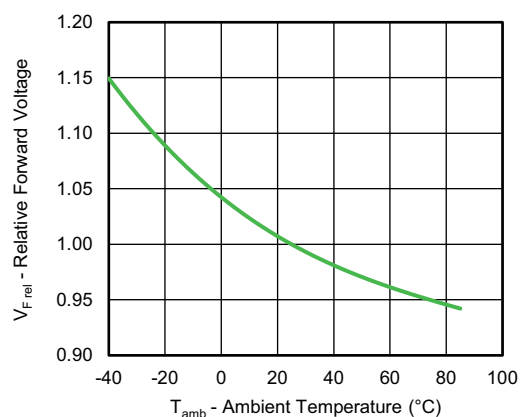


Fig. 7 - Relative Forward Voltage vs. Ambient Temperature

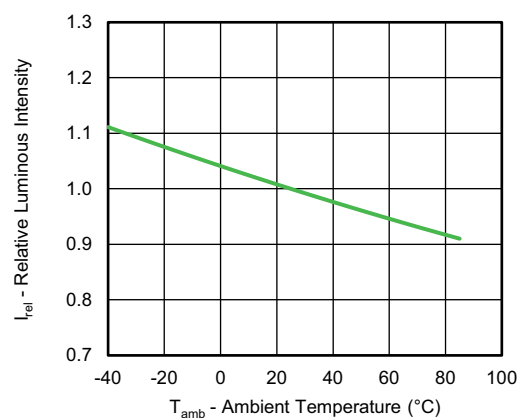


Fig. 8 - Relative Luminous Intensity vs. Ambient Temperature

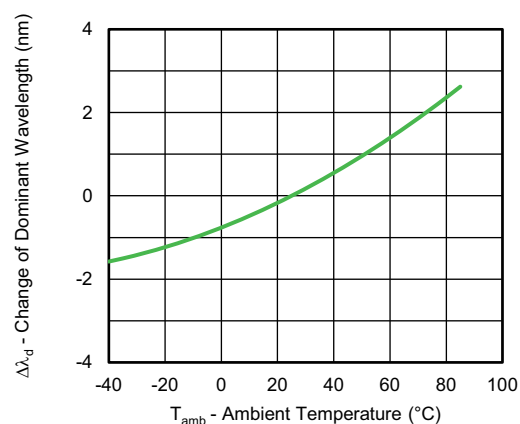
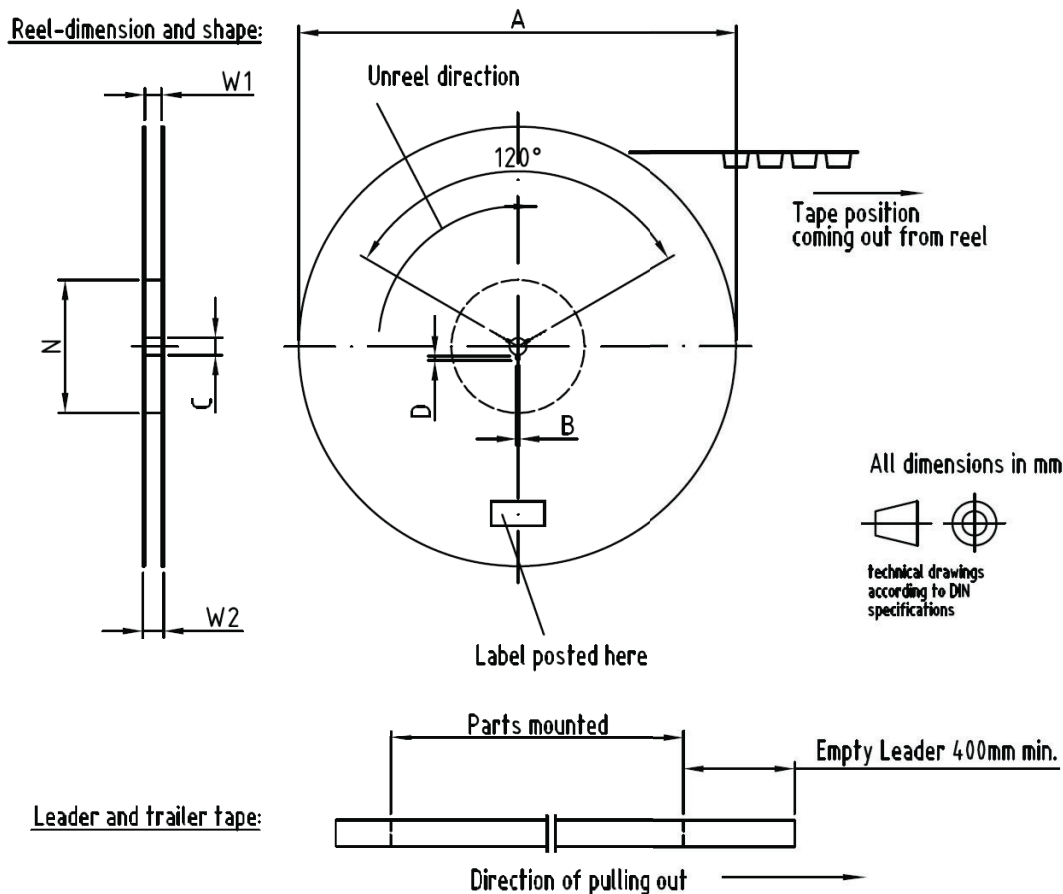


Fig. 9 - Change of Dominant Wavelength vs. Ambient Temperature

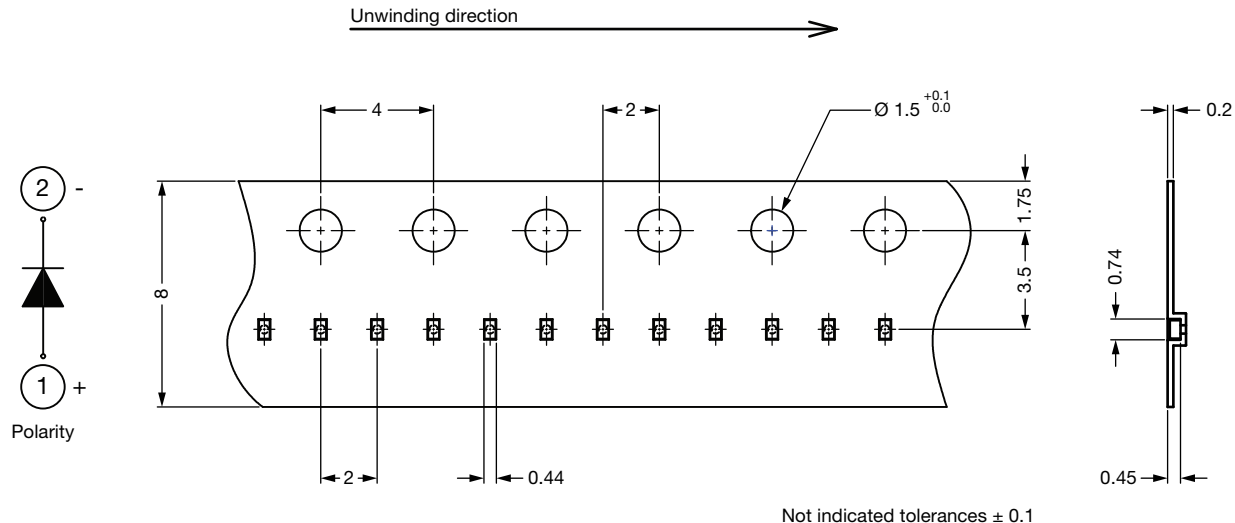
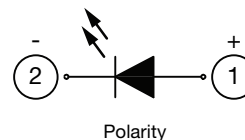
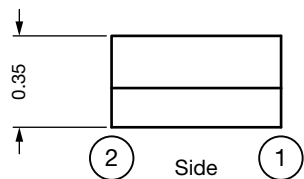
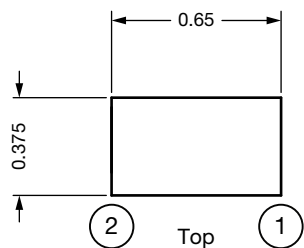
REEL DIMENSIONS in millimeters


Drawing-No.: 9.800-5172.01

Issue: VK; 18.04.24

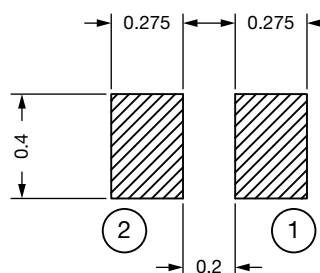
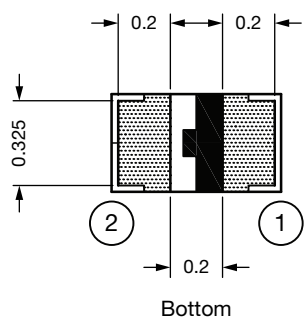
DIMENSIONS OF REEL in millimeters (according drawing reference)							
TAPING VERSION	A	B	C	D	N	W1	W2
GS08	$\varnothing 180 \pm 2$	2 ± 0.5	$\varnothing 13 \pm 0.2$	-	$\varnothing 60 + 0 / - 1$	$9 + 0.3 / - 0$	11.4 ± 1

Reels come in quantity of 3000 units.

TAPE DIMENSIONS in millimeters

PACKAGE DIMENSIONS in millimeters


Not indicated tolerances ± 0.1

Recommended solder pad


Note

- Suggested pad dimensions for reference only; please modify the pad dimensions based on individual need

SOLDERING PROFILE

IR Reflow Soldering Profile for lead (Pb)-free Soldering
Preconditioning acc. to JEDEC Level 3

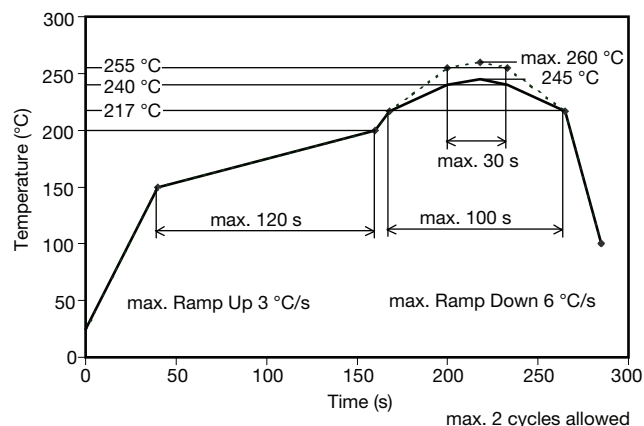
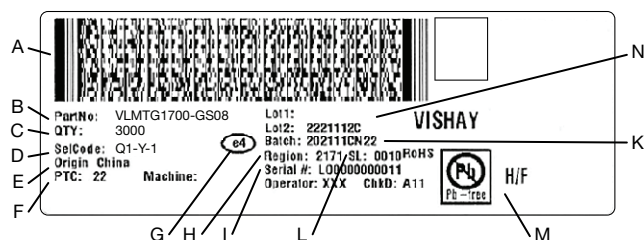


Fig. 10 - Vishay Lead (Pb)-free Reflow Soldering Profile
(according to J-STD-020C)

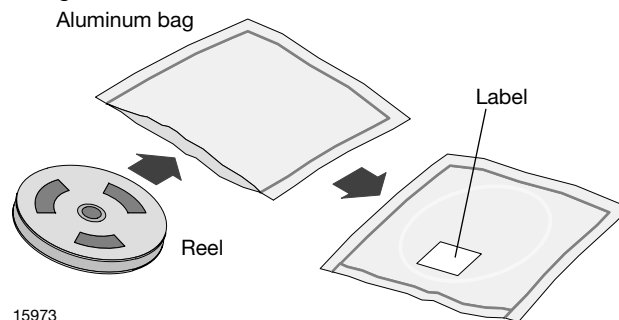
BAR CODE PRODUCT LABEL (Example only)



- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: product plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch Number: year, week, country code, plant code
- L. SL: storage location
- M. Environmental Symbols: RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

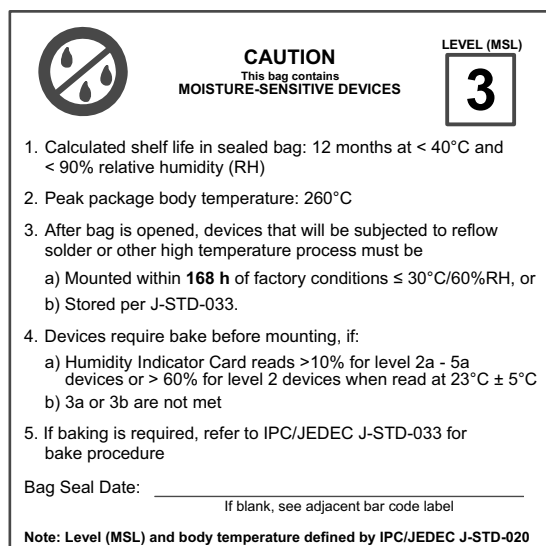
Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the condition given in J-STD-033.

A JEDEC J-STD-033 level 3 label is included on all aluminum dry bags.



Example of JEDEC J-STD-033 Level 3 Label



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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